

HCD-H550/H550M

SERVICE MANUAL

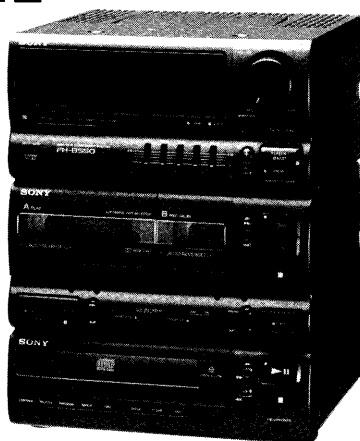



Photo: HCD-H550

AEP Model
E Model
Australian Model
PX Model
HCD-H550
US Model
Canadian Model
AEP Model
UK Model
HCD-H550M

HCD-H550/H550M are the CD player and stereo deck receiver in FH-B511/B550/MHC-550.

Dolby noise reduction manufactured under license from Dolby Laboratories Licensing Corporation. "DOLBY" and the double-D symbol  are trademarks of Dolby Laboratories Licensing Corporation.

SPECIFICATIONS

CD player section

System Compact disc digital audio system
 Laser Semiconductor laser
 Wavelength 780 - 790 nm

Tuner section

FM stereo, FM/AM superheterodyne tuner

FM tuner section

Tuning range
 Except CIS, EE
 JE, PX model : 87.5 - 108.0 MHz
 CIS, EE model : 65.0 - 74.0 MHz
 87.5 - 108.0 MHz
 JE, PX model : 76.0 - 108.0 MHz

Antenna
 HCD-H550 : Telescopic antenna
 HCD-H550M : FM lead antenna

Antenna terminals 75 ohm unbalanced
 Intermediate frequency 10.7 MHz

AM tuner section

Tuning range
 US, CND model : AM530 - 1,710 kHz

AEP, UK, CIS, EE model : MW531 - 1,602 kHz
 LW153 - 279 kHz
 G model : AM531 - 1,602 kHz
 IT model : AM522 - 1,611 kHz
 AUS model : MW531 - 1,602 kHz
 SW5.95 - 17.9 MHz
 E, EA, MX, MY, SP, PX, JE model : MW531 - 1,602 kHz
 (at 9 kHz step)
 MW530 - 1,710 kHz
 (at 10 kHz step)
 SW5.95 - 17.9 MHz

Antenna AM loop antenna
 External antenna terminals
 Intermediate frequency 450 kHz

Cassette deck section

Recording system 4-track 2-channel stereo
 Frequency response (DOLBY NR OFF)
 60 - 13,000 Hz (± 3 dB),
 using TYPE I cassette (Sony HF-S)

60 - 14,000 Hz (± 3 dB),
 using TYPE II cassette (Sony UX-S)
 Wow and flutter 0.1% WRMS $\pm 0.3\%$ (DIN)

Amplifier section

Continupus RMS Power output:
 30+30 watts (6 ohms at 1 kHz, 5% THD)
 Peak music power output:
 300 watts (2 speakers driven)
 Inputs
 MIX MIC (mini jack)
 (EXCEPT H550: AEP, G, CIS/H550M):
 Sensitivity 1 mV,
 impedance 600 ohms
 VIDEO/AUX (H550: EXCEPT AEP, G/
 H550M: US, CND): Sensitivity 450 mV,
 impedance 47 kilo ohms
 PHONO (phono jack)
 (AEP, UK, EE, G, IT): sensitivity 5 mV,
 impedance 47 kilohms

CD SECTION	Model Name Using Similar Mechanism	NEW
	CD Mechanism Type	CDM28-5BD17A
	Base Unit Type	BU-5BD17A
TAPE DECK SECTION	Model Name Using Similar Mechanism	TC-WR445
	Tape Transport Mechanism Type	TCM-220WR2

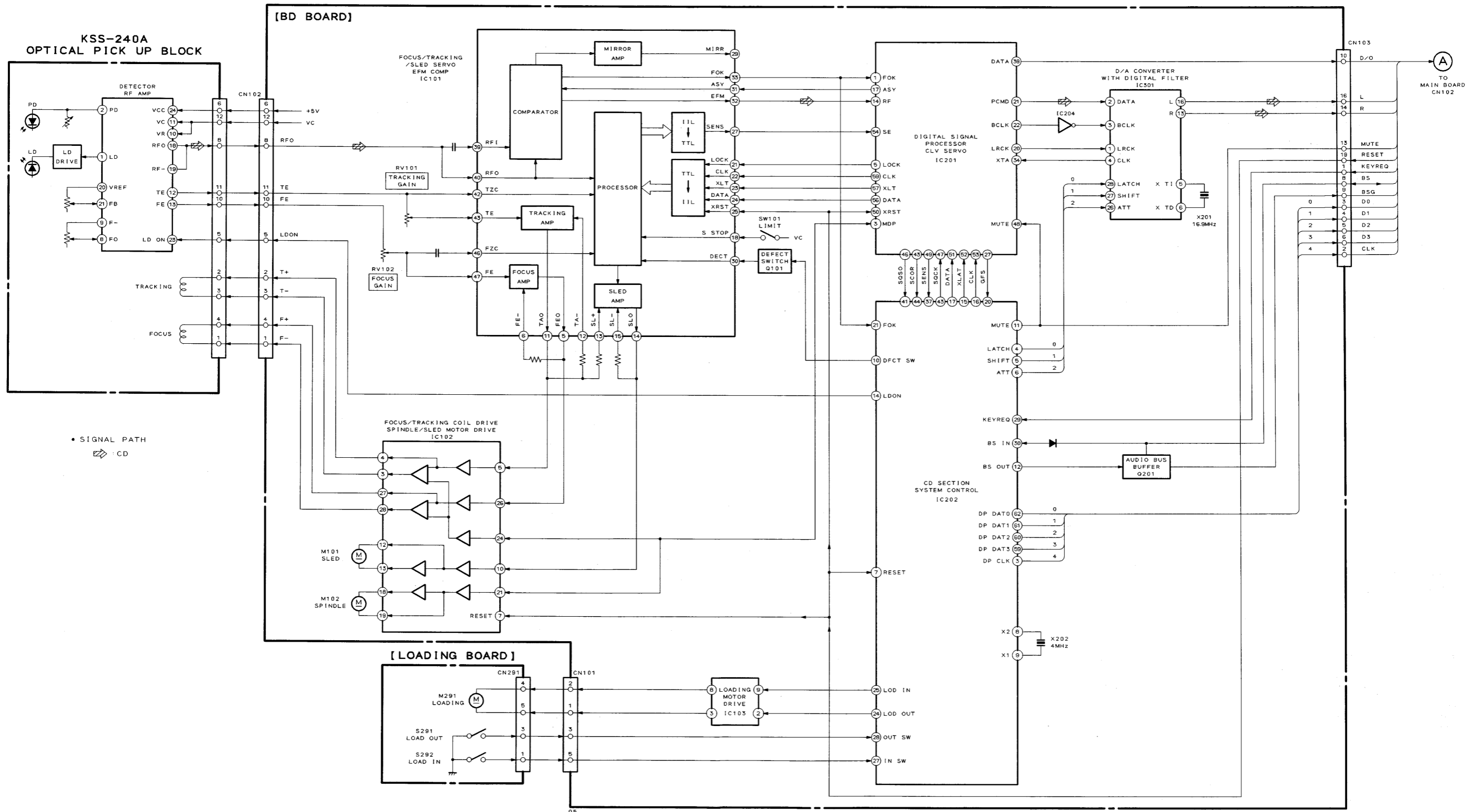
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MINI Hi-Fi COMPONENT SYSTEM
SONY

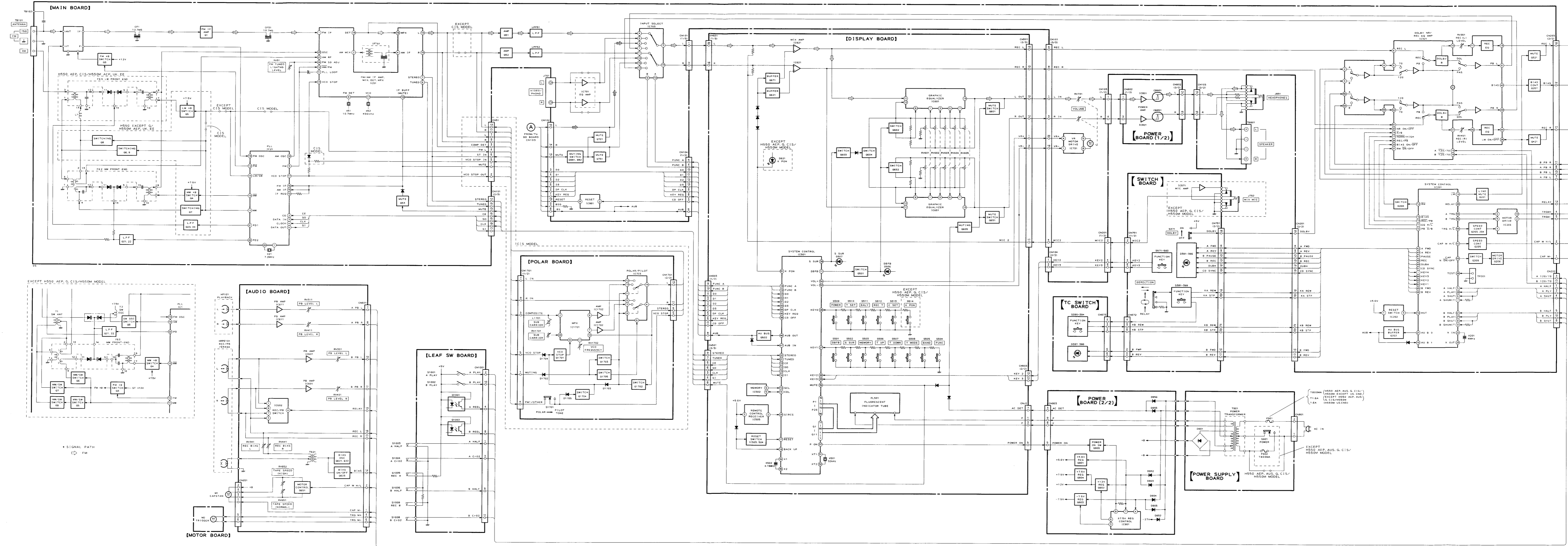


SECTION 5
DIAGRAMS

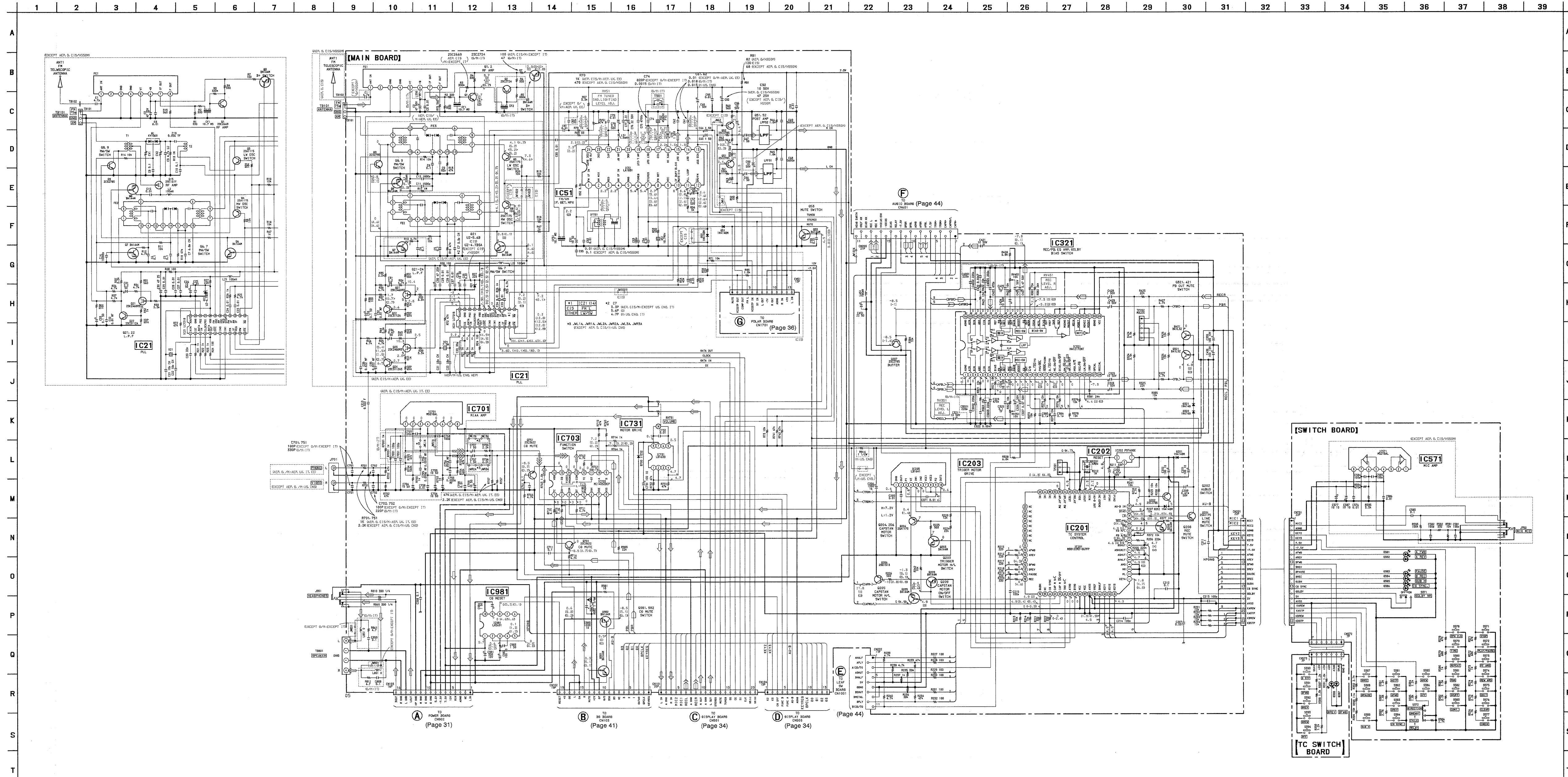
5-1. CD SECTION BLOCK DIAGRAM



5-2. OTHER SECTION BLOCK DIAGRAM

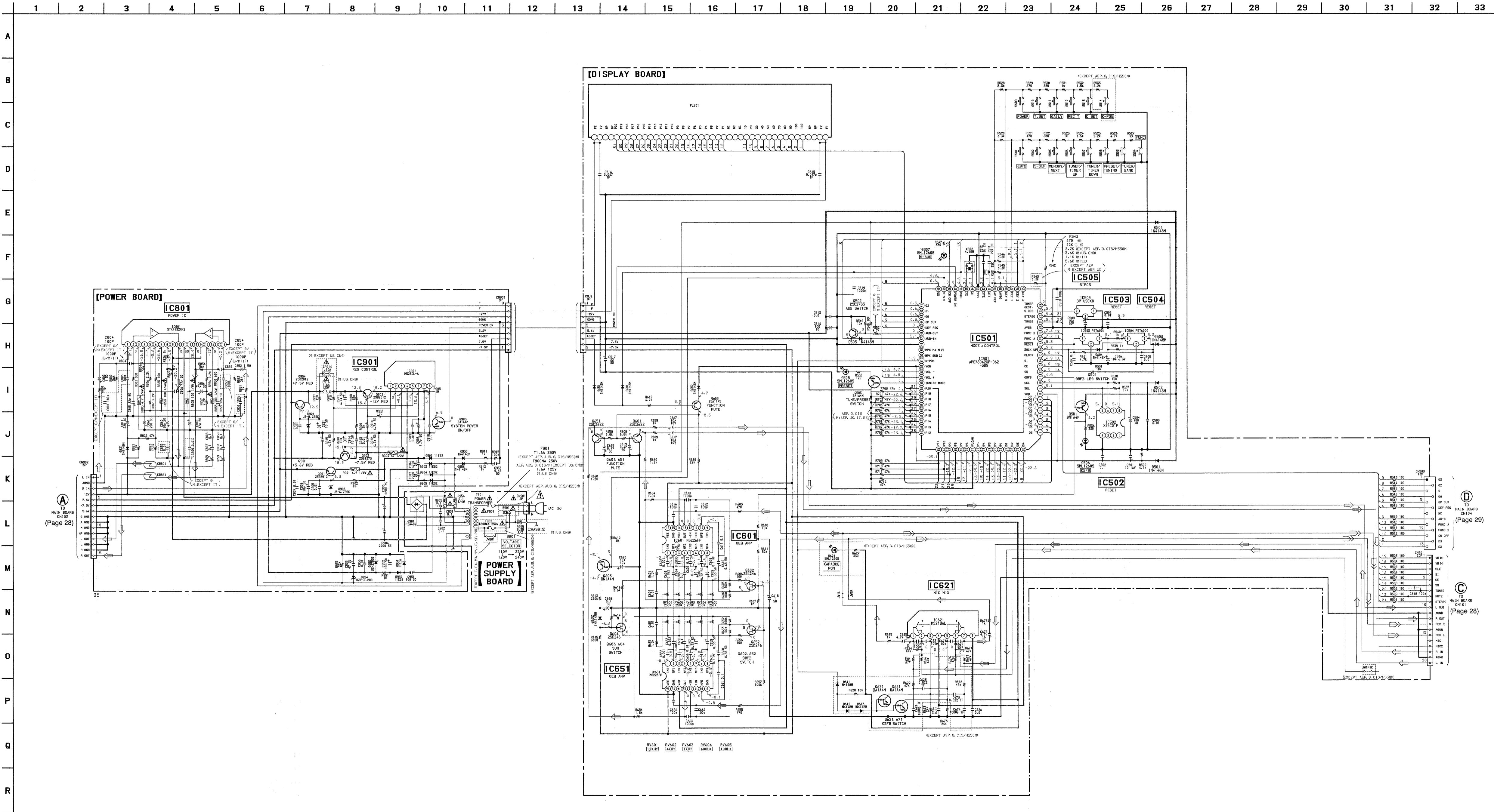


5-4. MAIN SECTION SCHEMATIC DIAGRAM
• See pages 31 to 34 for Display Section Schematic Diagram and page 49 for IC Block Diagrams.



Note: All capacitors are in μF unless otherwise noted. pF: μF 50 WV or less are not indicated except for electrolytics and tantalums. All resistors are in Ω and ¼ W or less unless otherwise specified. Internal component. Fusible resistor. The components identified by mark Δ or dotted line with mark Δ are critical for safety. Replace only with part number specified. Les composants identifiés par une marque Δ sont critiques pour la sécurité. Ne les remplacer que par une pièce portant le numéro spécifié. B+ Line, B- Line, panel designation, adjustment for repair. Voltages and waveforms are dc with respect to ground under no-signal (detuned) conditions. no mark: FM (Common), MW, LW, DECK B REC, DECK B PB, impossible to measure. Voltages are taken with a VOM (10 MΩ/V). Voltage variations may be noted due to normal production tolerances. Signal path: FM, PB (DECK B), REC (DECK B), CD, PHONO. Abbreviations: AUS: Australian, CND: Canadian, EA: Saudi Arabia, EE: East European, G: German, IT: Italian, JE: Tourist, MX: Mexican, MY: Malaysia, SP: Singapore.

5-5. DISPLAY SECTION SCHEMATIC DIAGRAM



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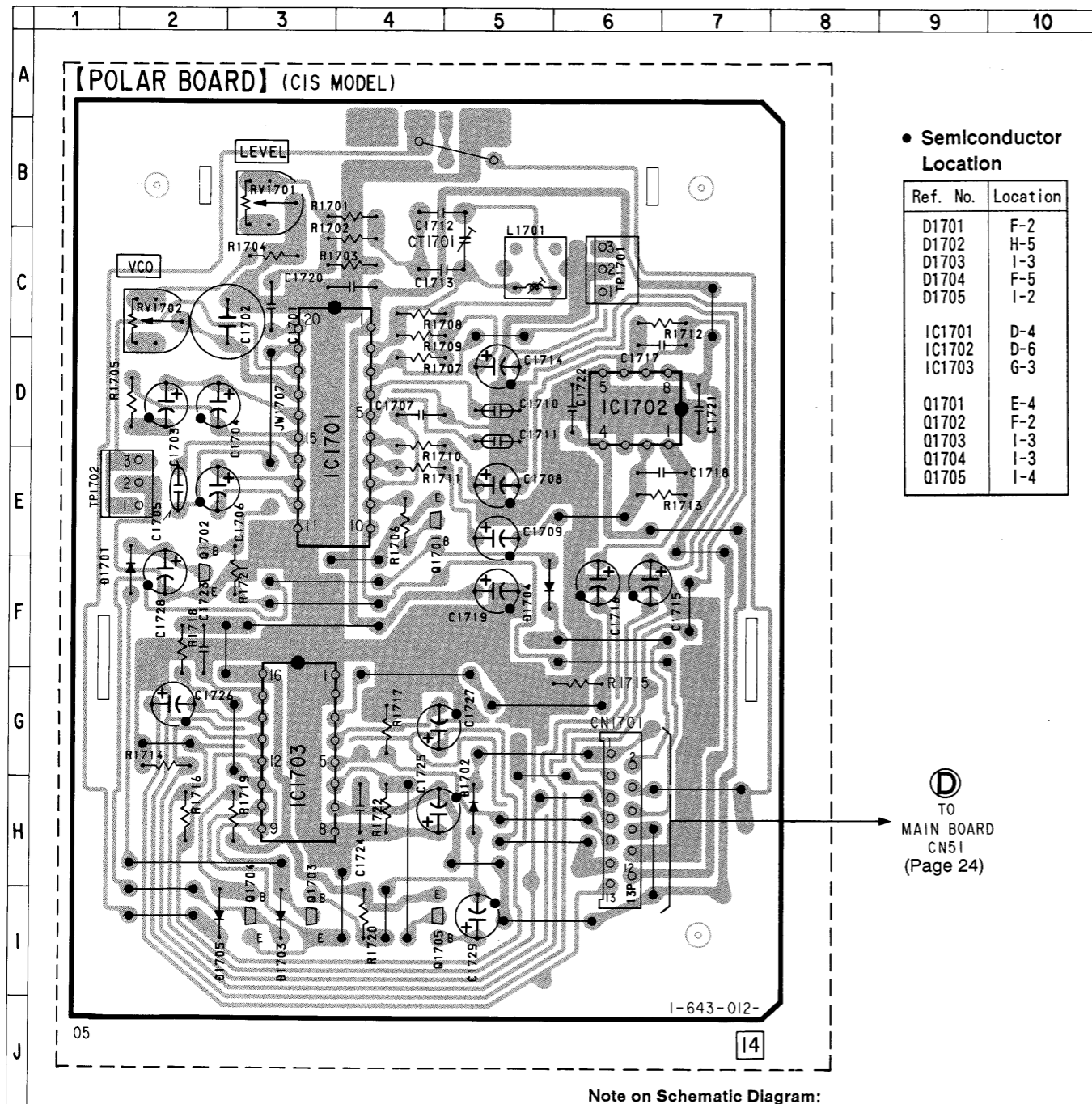
Note:
 • All capacitors are in μF unless otherwise noted. pF , μF , 50 WV or less are not indicated except for electrolytics and tantalums.
 • All resistors are in Ω and $\frac{1}{4}\text{ W}$ or less unless otherwise specified.
 • Δ : internal component.
 • --- : fusible resistor.

Note:
 The components identified by mark Δ or dotted line with mark Δ are critical for safety. Replace only with part number specified.

Note:
 Les composants identifiés par une marque Δ sont critiques pour la sécurité. Ne les remplacer que par une pièce portant le numéro spécifié.

• --- : B + Line.
 • --- : B - Line.
 • --- : panel designation.
 • Voltages and waveforms are dc with respect to ground under no-signal (detuned) conditions.
 no mark: FM
 * : Impossible to measure
 • Voltages are taken with a VOM (10 $\text{M}\Omega/\text{V}$). Voltage variations may be noted due to normal production tolerances.
 • Signal path.
 --- : FM
 --- : REC (DECK B)
 • Abbreviations
 AUS : Australian IT : Italian
 CND : Canadian JE : Tourist
 EA : Saudi Arabia MX : Mexican
 EE : East European MY : Malaysia
 G : German SP : Singapore

5-6. POLAR PRINTED WIRING BOARD AND SCHEMATIC DIAGRAM
See page 47 for Semiconductor Lead Layouts and Circuit Boards Location.



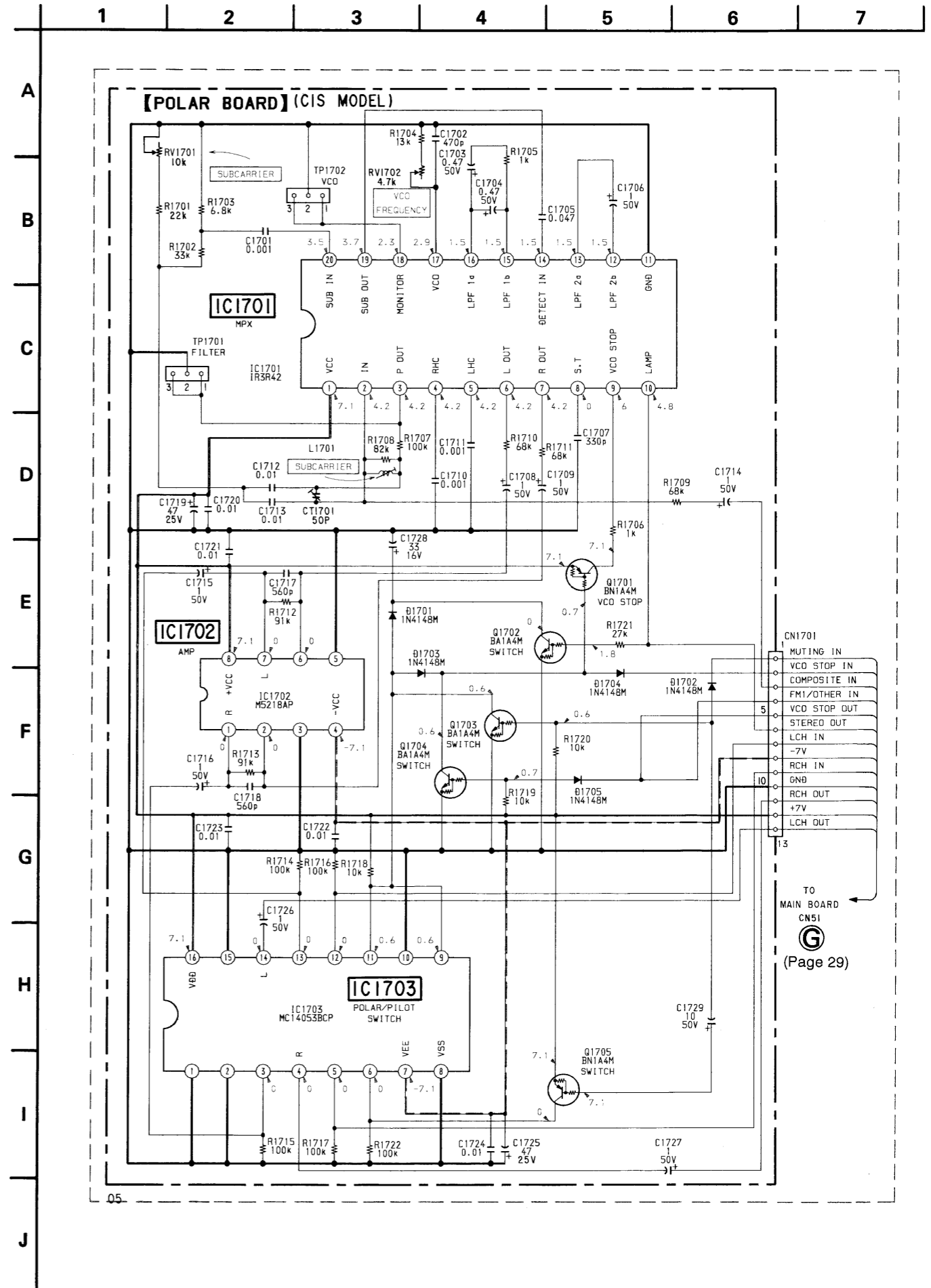
• Semiconductor Location

Ref. No.	Location
D1701	F-2
D1702	H-5
D1703	I-3
D1704	F-5
D1705	I-2
IC1701	D-4
IC1702	D-6
IC1703	G-3
Q1701	E-4
Q1702	F-2
Q1703	I-3
Q1704	I-3
Q1705	I-4

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TO
MAIN BOARD
CN51
(Page 24)

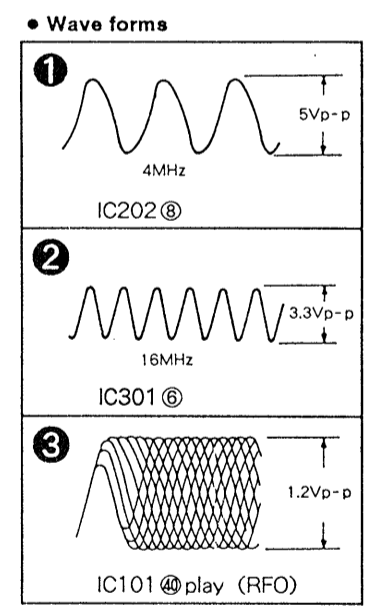
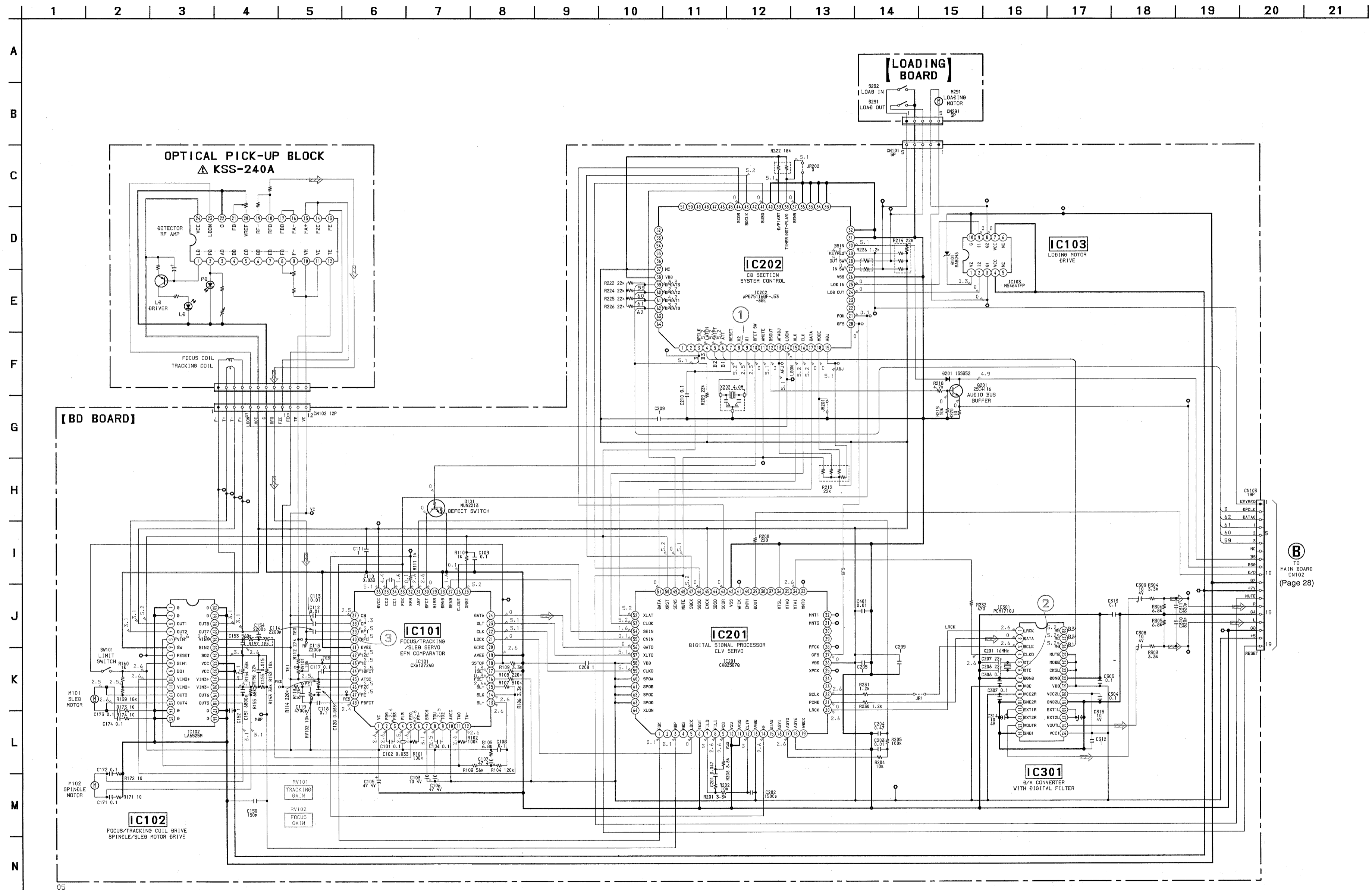
Note on Schematic Diagram:

- All capacitors are in μF unless otherwise noted. pF: μpF 50 WV or less are not indicated except for electrolytics and tantalums.
- All resistors are in Ω and $\frac{1}{4}$ W or less unless otherwise specified.
- : B + Line.
- : B - Line.
- : adjustment for repair.
- Voltages and waveforms are dc with respect to ground under no-signal (detuned) conditions.
no mark : FM
- Voltages are taken with a VOM (10 M Ω /V).
Voltage variations may be noted due to normal production tolerances.



TO
MAIN BOARD
CN51
Ⓔ
(Page 29)

5-8. CD SECTION SCHEMATIC DIAGRAM • See page 49 for IC Block Diagrams.



Note:

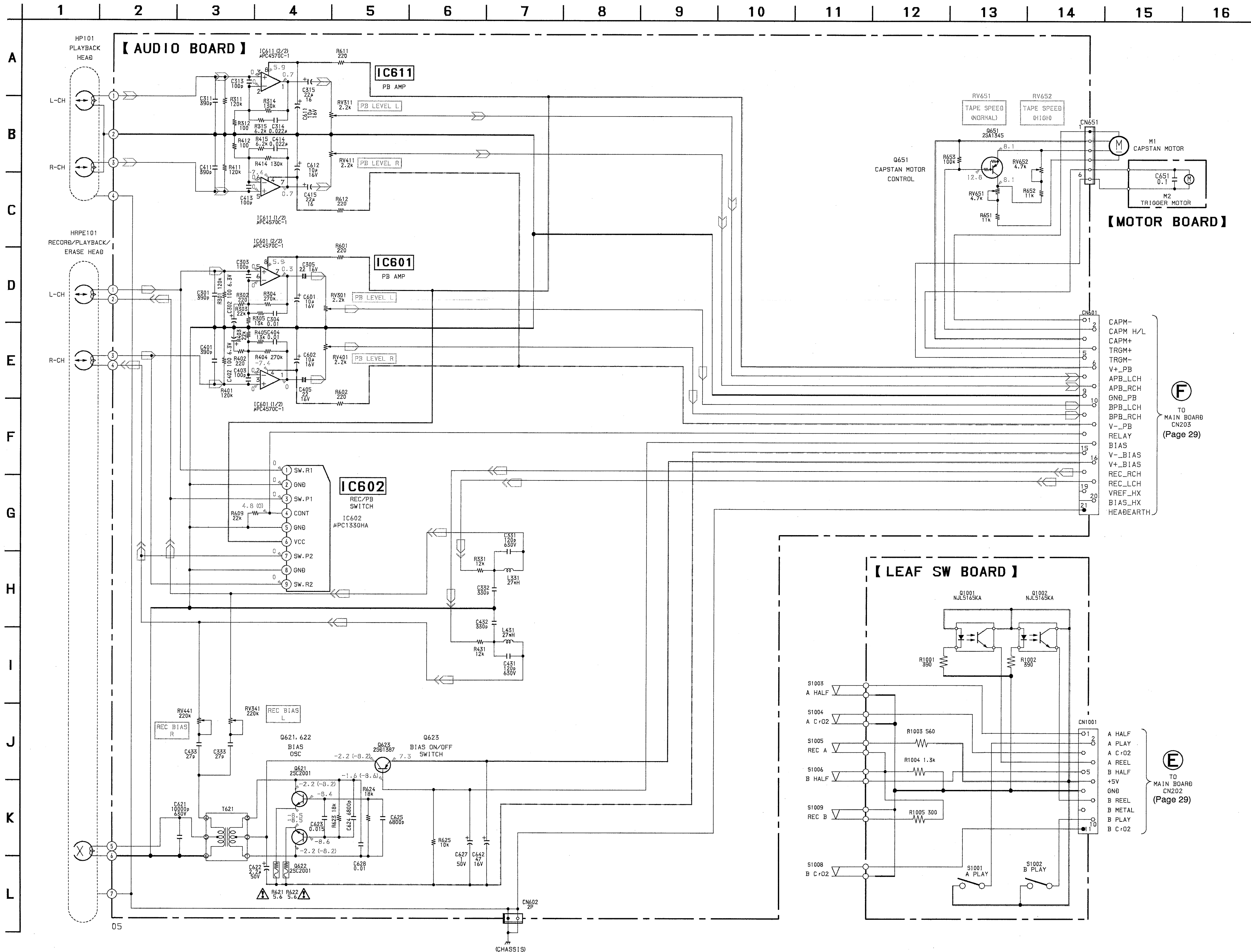
- All capacitors are in μF unless otherwise noted. pF: μF 50 WV or less are not indicated except for electrolytics and tantalums.
- All resistors are in Ω and $\frac{1}{4}$ W or less unless otherwise specified.
- Δ : internal component.

Note:
The components identified by mark Δ or dotted line with mark Δ are critical for safety. Replace only with part number specified.

Note:
Les composants identifiés par une marque Δ sont critiques pour la sécurité. Ne les remplacer que par une pièce portant le numéro spécifié.

- --- : B + Line.
- --- : adjustment for repair.
- Voltages and waveforms are dc with respect to ground under no-signal (detuned) conditions. no mark: CD
- Voltages are taken with a VOM (10 M Ω /V). Voltage variations may be noted due to normal production tolerances.
- Waveforms are taken with an oscilloscope. Voltage variations may be noted due to normal production tolerances.
- Circled numbers refer to waveforms.
- Signal path.
- --- : CD

(B) MAIN BOARD CN102 (Page 28)



TO MAIN BOARD CN203 (Page 29)

CAPM-
CAPM H/L
CAPM+
TRGM+
TRGM-
V+_PB
APB_LCH
APB_RCH
GND_PB
BPB_LCH
BPB_RCH
V-_PB
RELAY
BIAS
V-_BIAS
V+_BIAS
REC_RCH
REC_LCH
VREF_HX
BIAS_HX
HEADERTH

F

E

Note:
• All capacitors are in μF unless otherwise noted. μF : μF , μF 50 WV or less are not indicated except for electrolytics and tantalums.
• All resistors are in Ω and $\frac{1}{4}$ W or less unless otherwise specified.
• --- : fusible resistor.

Note:
The components identified by mark Δ or dotted line with mark Δ are critical for safety.
Replace only with part number specified.

Note:
Les composants identifiés par une marque Δ sont critiques pour la sécurité.
Ne les remplacer que par une pièce portant le numéro spécifié.

• --- : B + Line.
• --- : B - Line.
• --- : adjustment for repair.
• Voltages and waveforms are dc with respect to ground under no-signal (detuned) conditions.
no mark: REC (Common)
(): PB
• Voltages are taken with a VOM (10 M Ω /V).
Voltage variations may be noted due to normal production tolerances.
• Signal path.
 \square : PB (DECK B)
 --- : REC (DECK A)
 --- : REC (DECK B)